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CONFIRMATION NO. 1307

SERIAL NUMBER	FILING or 371(c) DATE	CLASS	GROUP ART UNIT	ATTORNEY DOCKET NO.		
10/562,725	05/23/2006	148	1793	520.45782X00		
RULE						
APPLICANTS Tetsuya Nakatsuka, Tokyo, JAPAN; Nobuhide Takano, Tokyo, JAPAN; Tadayuki Sugahara, Tokyo, JAPAN; Tomoyuki Omura, Tokyo, JAPAN; Toshio Saeki, Tokyo, JAPAN; Kouji Serizawa, Tokyo, JAPAN; Shousaku Ishihara, Tokyo, JAPAN; ** CONTINUING DATA ***** EPB This application is a 371 of PCT/JP04/09679 07/01/2004 ** FOREIGN APPLICATIONS ***** EPB JAPAN 2003-189290 07/01/2003 ** IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 07/19/2006						
Foreign Priority claimed <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No 35 USC 119(a-d) conditions met <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No Verified and /ERIN P BARRY/ Acknowledged Examiner's Signature		<input type="checkbox"/> Met after Allowance Initials	STATE OR COUNTRY	SHEETS DRAWINGS	TOTAL CLAIMS	INDEPENDENT CLAIMS
			JAPAN	6	17	2
ADDRESS ANTONELLI, TERRY, STOUT & KRAUS, LLP 1300 NORTH SEVENTEENTH STREET SUITE 1800 ARLINGTON, VA 22209-3873 UNITED STATES						
TITLE Reflow soldering method using Pb-free solder alloy and hybrid packaging method and structure						
FILING FEE RECEIVED 1390	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:			<input type="checkbox"/> All Fees		
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